

**IN THE CLAIMS:**

This Listing of Claims will replace all prior versions, and listings, of claims in the subject Patent Application:

**Listing of Claims:**

1. (Currently amended) An automatic package process for a card, comprising the steps of:

transferring a metal belt;

stamping said metal belt to form a first and second metal shells without releasing from said metal belt, said first and second metal shells having a plurality of strips extending therefrom;

bending said strips to form a plurality of stakes;

injection molding a first and second plastic frames on said first and second metal shells, respectively, said first and second plastic frames having said stakes embedded therein; and

combining said first and second plastic frames to form a case.

2. (Original) A process of claim 1, further comprising printing patterns on said first and second metal shells after forming said first and second plastic frames.

3. (Original) A process of claim 1, wherein said stamping for first and second metal shells comprises forming a plurality of strips on opposite sides of said metal shells.

4. (Original) A process of claim 3, further comprising bending said strips for forming stakes.

5. (Original) A process of claim 1, further comprising stamping said first metal shell for forming a bent extension.

6. (Original) A process of claim 4, wherein said first and second plastic frames embed said stakes on said first and second metal shells, respectively.

7. (Original) A process of claim 5, wherein said second plastic frame embeds said bent extension of said second metal shell.

8. (Original) A process of claim 1, wherein said first and second plastic frames are combined together by sonic welding.

9. (Original) A process of claim 1, wherein said metal belt is coated with an insulator film thereon.

10. (Original) A process of claim 1, further comprising removing said first and second metal shells from said metal belt after injection molding said first and second plastic frames.

11. (Currently amended) A package for a small card with a thickness not larger than 3.3 mm, said package comprising:

first and second metal shells each having a thickness not larger than 0.15 mm, a plurality of stakes extending therefrom, and an inner surface coated with an insulator film; and

first and second plastic frames ~~embedding~~ having said ~~plurality of~~ stakes embedded therein, to respectively, ~~to~~ form with said first and second metal shells first and second half cases, said first plastic frame having a thickness not larger than 0.7 mm, said second plastic frame having a thickness not larger than 1.4 mm;

wherein said first and second plastic frames are combined together to form a case.

12. (Original) A package of claim 11, wherein said first and second plastic frames have a recess.

13. (Original) A package of claim 11, wherein said second plastic frame has an I/O portion on which said second metal shell has a bent extension embedded therewith.

14. (Original) A package of claim 11, wherein said first and second plastic frames are combined by a glue.

15. (Original) A package of claim 11, wherein said first and second plastic frames are combined by a sonic welding.

16. (Currently amended) A package of claim 11, wherein said insulator film comprises a ~~Teflon~~ polytetrafluoroethylene material.

17. (New) A process of claim 1, wherein at least one of said first and second metal shells is stamped to include an elongate bent extension transversely disposed relative to a plurality of said stakes, said bent extension being embedded within one of said first and second plastic frames.

18. (New) A package of claim 11, wherein at least one of said first and second metal shells includes an elongate bent extension transversely disposed relative to a

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plurality of said stakes, said bent extension being embedded within one of said first and second plastic frames.